

SGM8061 SGM8062 SGM8063

500MHz, Rail-to-Rail Output CMOS Operational Amplifier

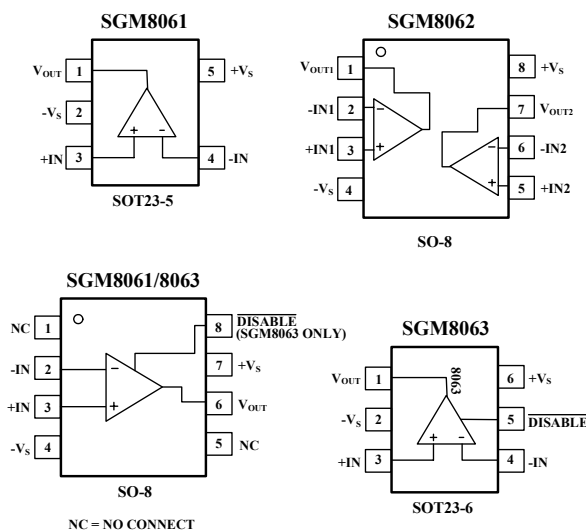
PRODUCT DESCRIPTION

The SGM8061, SGM8062, SGM8063 are rail-to-rail output voltage feedback amplifiers offering ease of use and low cost. They have bandwidth and slew rate typically found in current feedback amplifiers. All have a wide input common-mode voltage range and output voltage swing, making them easy to use on single supplies as low as 2.5 V.

Despite being low cost, the SGM8061 series provide excellent overall performance. they offer wide bandwidth to 500 MHz ($G=+1$) along with 0.1 dB flatness out to 130 MHz ($G=+1$) and offer a typical low power of 8.2 mA/amplifier.

The SGM8061 series is low distortion and fast settling make it ideal for buffering high speed A/D or D/A converters. The SGM8063 has a power-down disable feature that reduces the supply current to 75 μ A. These features make the SGM8063 ideal for portable and battery-powered applications where size and power are critical. All are specified over the extended -40°C to $+125^{\circ}\text{C}$ temperature range.

PIN CONFIGURATIONS (Top View)

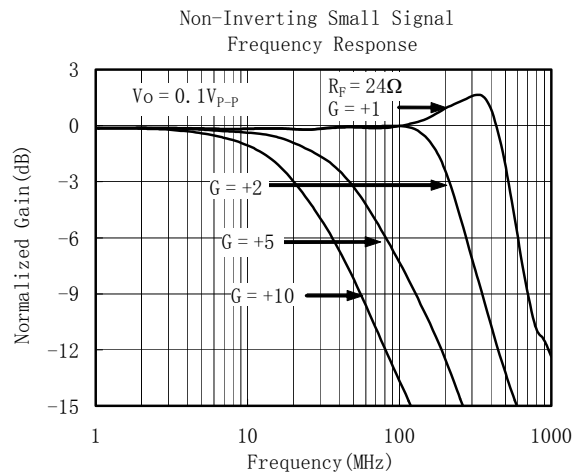


FEATURES

- Low Cost
- Rail-to-Rail Output
2mV Typical V_{OS}
- High Speed
500 MHz, -3 dB Bandwidth ($G=+1$)
420 V/ μ s, Slew Rate
16 ns Settling Time to 0.1% with 2V Step
- Operates on 2.5 V to 5.5V Supplies
- Input Voltage Range = -0.2 V to $+3.8\text{ V}$ with $V_S = 5\text{ V}$
- Excellent Video Specs ($R_L = 150\Omega$, $G = +2$)
Gain Flatness 0.1dB to 80 MHz
Diff Gain: 0.015 %, Diff Phase: 0.05 degree
- Low Power
8.2 mA/Amplifier Typical Supply Current
SGM8063 75 μ A when Disabled
- Small Packaging
SGM8061 Available in SO-8 and SOT23-5
SGM8062 Available in SO-8
SGM8063 Available in SO-8 and SOT23-6

APPLICATIONS

- Imaging
- Photodiode Preamp
- Professional Video and Cameras
- Hand Sets
- DVD/CD
- Base Stations
- Filters
- A-to-D Driver



ELECTRICAL CHARACTERISTICS : $V_S = +5V$

($G=+2$, $R_F = 402\Omega$, $R_L = 150\Omega$, unless otherwise noted)

PARAMETER	CONDITION	SGM8061/2/3						UNITS	MIN/ MAX
		TYP	MIN/MAX OVER TEMPERATURE						
		+25°C	+25°C	0°C to 70°C	-40°C to 85°C	-40°C to 125°C			
DYNAMIC PERFORMANCE									
-3dB Small Signal Bandwidth	$G = +1$, $V_o = 0.1 V$ p-p, $R_F = 24\Omega$, $G = +1$, $V_o = 0.1 V$ p-p, $R_F = 24\Omega$, $R_L = 1K\Omega$ $G = +2$, $V_o = 0.1 V$ p-p, $R_L = 50\Omega$ $G = +2$, $V_o = 0.1 V$ p-p, $R_L = 150\Omega$ $G = +2$, $V_o = 0.1 V$ p-p, $R_L = 1k\Omega$ $G = +2$, $V_o = 0.1 V$ p-p, $R_L = 10k\Omega$	500 550 130 210 250 420					MHz MHz MHz MHz MHz MHz	TYP TYP TYP TYP TYP TYP	
Gain-Bandwidth Product	$G = +10$, $R_L = 150\Omega$ $G = +10$, $R_L = 1K\Omega$	200 230					MHz MHz	TYP TYP	
Bandwidth for 0.1dB Flatness	$G = +1$, $V_o = 0.1 V$ p-p, $R_F = 24\Omega$ $G = +2$, $V_o = 0.1 V$ p-p, $R_F = 330\Omega$	130 80					MHz MHz	TYP TYP	
Slew Rate	$G = +1$, 2V Output Step $G = +2$, 2V Output Step $G = +2$, 4V Output Step	320/-370 350/-320 420/-390					V/ μ S V/ μ S V/ μ S	TYP TYP TYP	
Rise-and-Fall Time	$G = +2$, $V_o = 0.2 V$ p-p, 10% to 90% $G = +2$, $V_o = 2 V$ p-p, 10% to 90%	4 4.5					ns ns	TYP TYP	
Settling Time to 0.1%	$G = +2$, 2 V Output Step	16					ns	TYP	
Overload Recovery Time	$V_{IN} \cdot G = +V_S$	6.2					ns	TYP	
NOISE/DISTORTION PERFORMANCE									
Harmonic Distortion									
2nd-Harmonic	$G = +2$, $f = 1MHz$, $V_o = 2Vp-p$, $R_L = 150\Omega$						dBc	TYP	
3rd-Harmonic	$G = +2$, $f = 1MHz$, $V_o = 2Vp-p$, $R_L = 150\Omega$						dBc	TYP	
Input Voltage Noise	$f = 1MHz$	5.6					nV/ \sqrt{Hz}	TYP	
Input Current Noise	$f = 1MHz$						fA/ \sqrt{Hz}	TYP	
Differential Gain Error (NTSC)	$G = +2$, $R_L = 150\Omega$	0.015					%	TYP	
Differential Phase Error (NTSC)	$G = +2$, $R_L = 150\Omega$	0.05					degree	TYP	
DC PERFORMANCE									
Input Offset Voltage (V_{OS})		± 2	± 8	± 8.5	± 9	± 9.3	mV	MAX	
Input Offset Voltage Drift		3					$\mu V/^\circ C$	TYP	
Input Bias Current (I_B)		6					pA	TYP	
Input offset Current (I_{OS})		2					pA	TYP	
Open-Loop Gain (A_{OL})	$V_O = 0.3 V$ to $4.7 V$, $R_L = 150\Omega$ $V_O = 0.2 V$ to $4.8 V$, $R_L = 1K\Omega$	80 104	75 90	75 90	74 89	70 80	dB dB	MIN MIN	
INPUT CHARACTERISTICS									
Input Common-Mode Voltage Range (V_{CM})		-0.2 to +3.8					V	TYP	
Common-Mode Rejection Ratio(CMRR)	$V_{CM} = -0.1 V$ to $+3.5 V$	80	66	65	64	62	dB	MIN	
OUTPUT CHARACTERISTICS									
Output Voltage Swing from Rail	$R_L = 150\Omega$ $R_L = 1K\Omega$	0.12 0.03					V V	TYP TYP	
Output Current		120	100	98	93	87	mA	MIN	
Closed-Loop Output Impedance	$f < 100kHz$	0.015					Ω	TYP	
POWER-DOWN DISABLE									
Turn-On Time		50					ns	TYP	
Turn-Off Time		44					ns	TYP	
$\overline{DISABLE}$ Voltage-Off			0.8				V	MAX	
$\overline{DISABLE}$ Voltage-On			2				V	MIN	
POWER SUPPLY									
Operating Voltage Range			2.5 5.5	2.7 5.5	2.7 5.5	2.7 5.5	V V	MIN MAX	
Quiescent Current (per amplifier)		8.2	10	10.3	10.5	11	mA	MAX	
Supply Current when Disabled (SGM8063 only)		75	120	127	130	139	μA	MAX	
Power Supply Rejection Ratio (PSRR)	$\Delta V_S = +2.7V$ to $+5.5V$, $V_{CM} = (-V_S) + 0.5$	80	66	66	65	63	dB	MIN	

Specifications subject to change without notice.

PACKAGE/ORDERING INFORMATION

MODEL	ORDER NUMBER	PACKAGE DESCRIPTION	PACKAGE OPTION	MARKING INFORMATION
SGM8061	SGM8061XN5/TR	SOT23-5	Tape and Reel, 3000	8061
	SGM8061XS/TR	SO-8	Tape and Reel,2500	SGM8061XS
SGM8062	SGM8062XS/TR	SO-8	Tape and Reel, 2500	SGM8062XS
SGM8063	SGM8063XN6/TR	SOT23-6	Tape and Reel,3000	8063
	SGM8063XS/TR	SO-8	Tape and Reel,2500	SGM8063XS

ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V+ to V- 7.5 V
Common-Mode Input Voltage
..... $(-V_S) - 0.5 V$ to $(+V_S) + 0.5V$
Storage Temperature Range -65°C to $+150^{\circ}\text{C}$
Junction Temperature 160°C
Operating Temperature Range -55°C to $+150^{\circ}\text{C}$
Package Thermal Resistance @ $T_A = 25^{\circ}\text{C}$
SOT23-5, θ_{JA} $190^{\circ}\text{C}/\text{W}$
SOT23-6, θ_{JA} $190^{\circ}\text{C}/\text{W}$
SO-8, θ_{JA} $125^{\circ}\text{C}/\text{W}$
Lead Temperature Range (Soldering 10 sec)
..... 260°C
ESD Susceptibility
HBM.....1000V
MM.....400V

NOTES

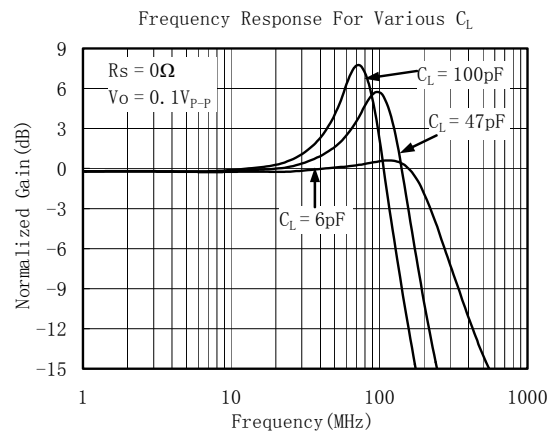
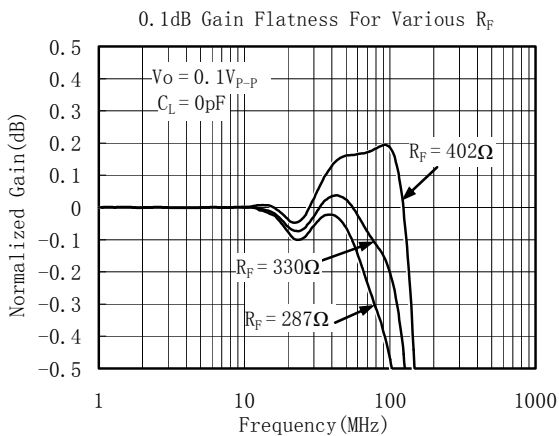
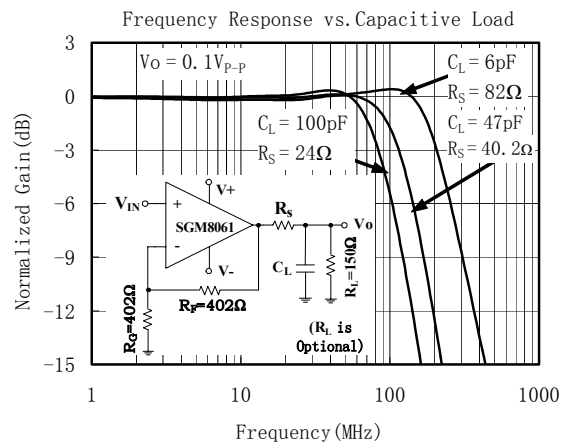
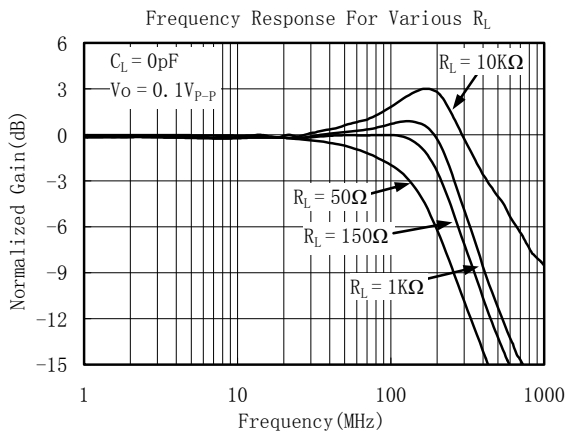
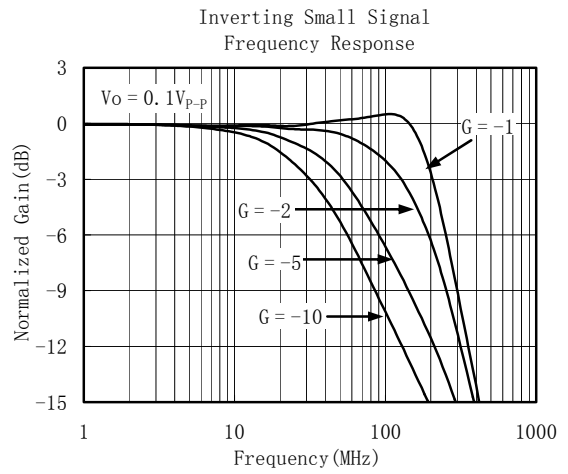
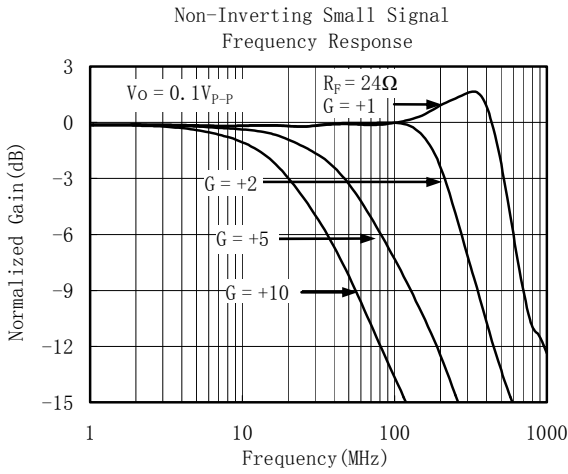
1. Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

CAUTION

This integrated circuit can be damaged by ESD. Shengbang Micro-electronics recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

TYPICAL PERFORMANCE CHARACTERISTICS

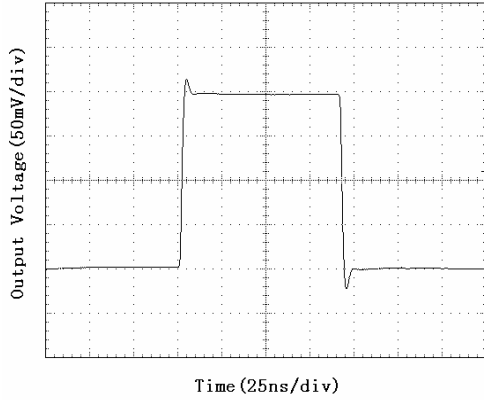
At $T_A = +25^\circ\text{C}$, $V_S = +5\text{V}$, $G = +2$, $R_F = 402\Omega$, $R_G = 402\Omega$, and $R_L = 150\Omega$ connected to $V_S/2$, unless otherwise noted.



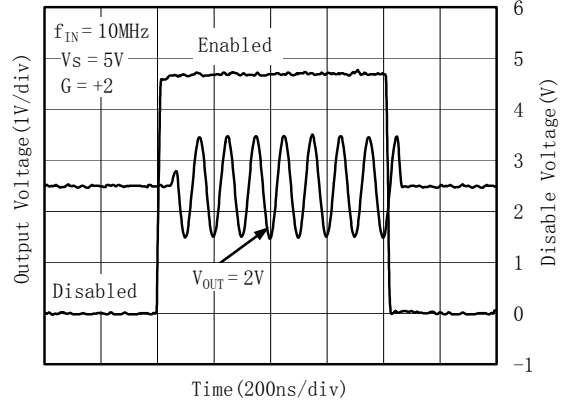
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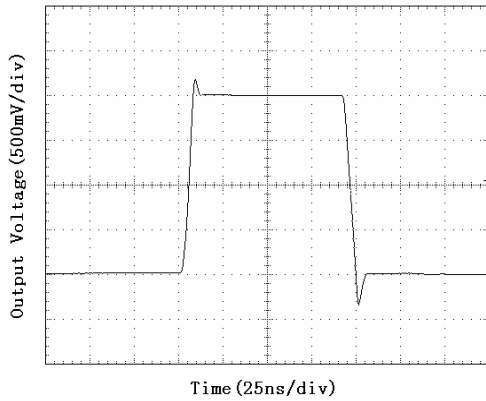
Non-Inverting Small Signal Step Response



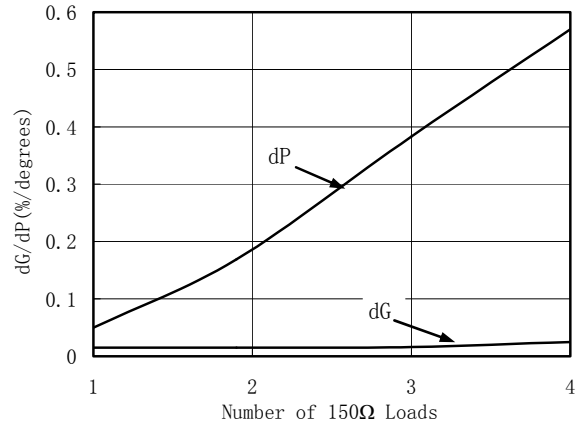
Large-Signal Disable/Enable Response



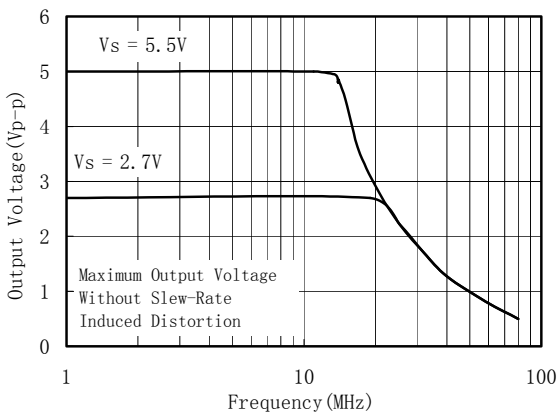
Non-Inverting Large Signal Step Response



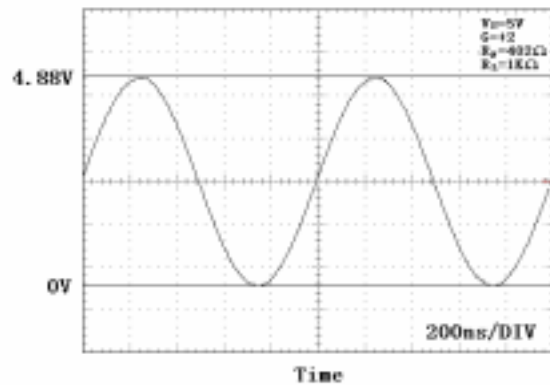
Composite Video Differential Gain And Phase



Maximum Output Voltage vs. Frequency

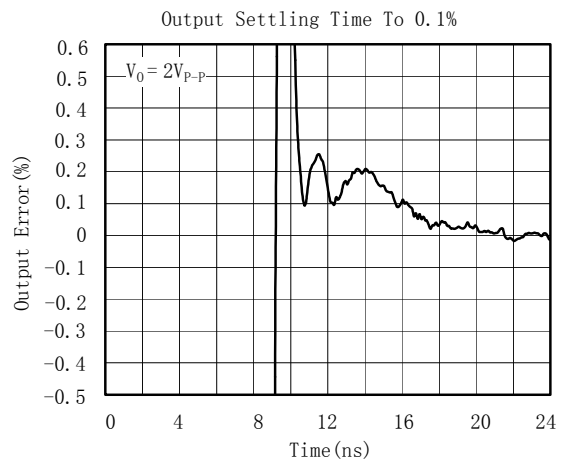
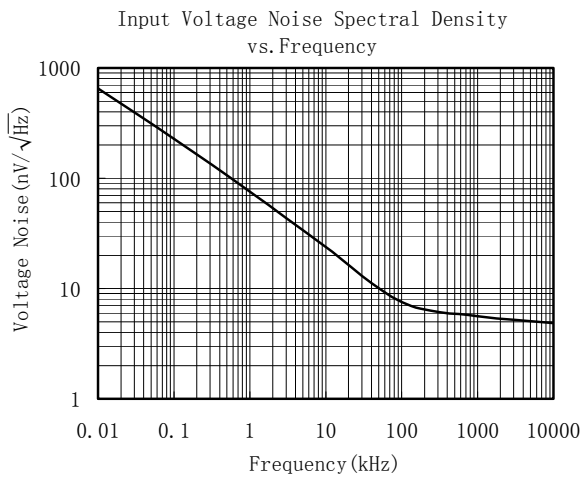
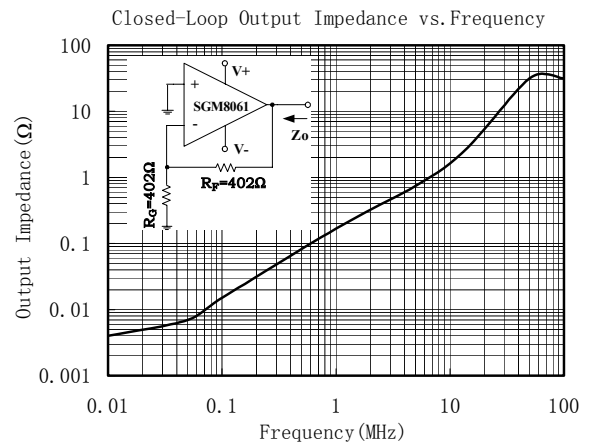
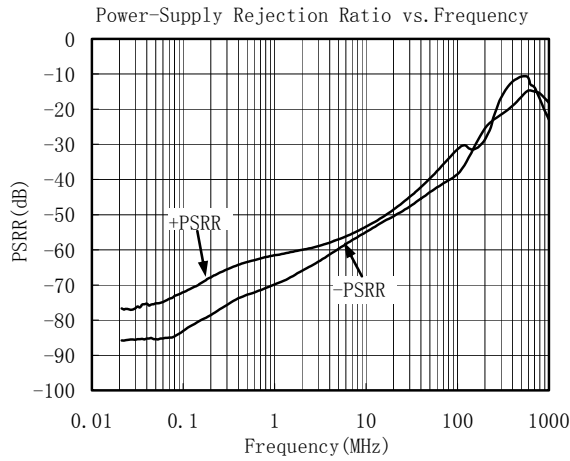
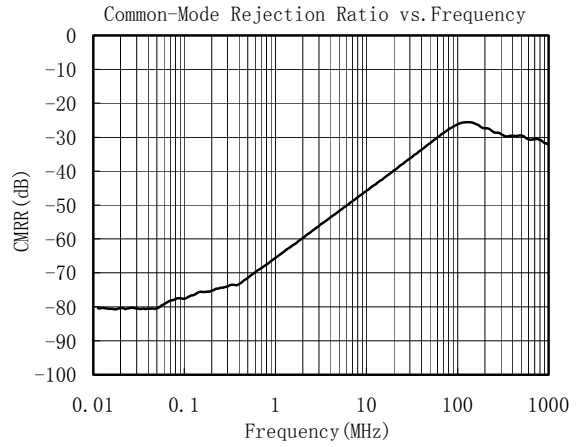
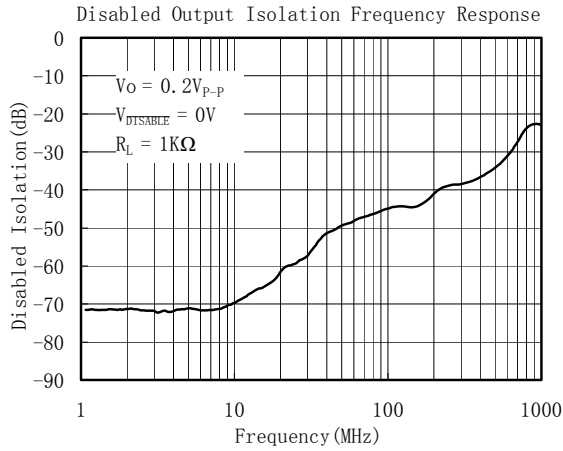


Rail-To-Rail



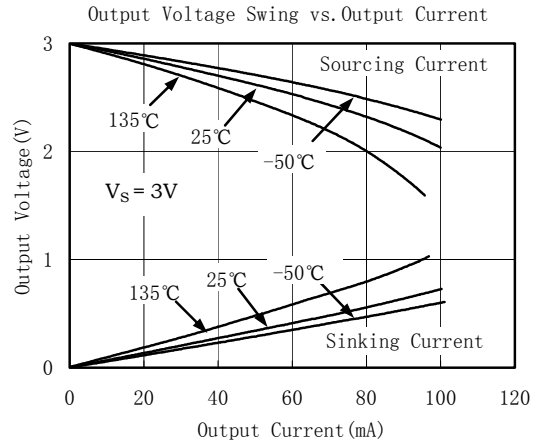
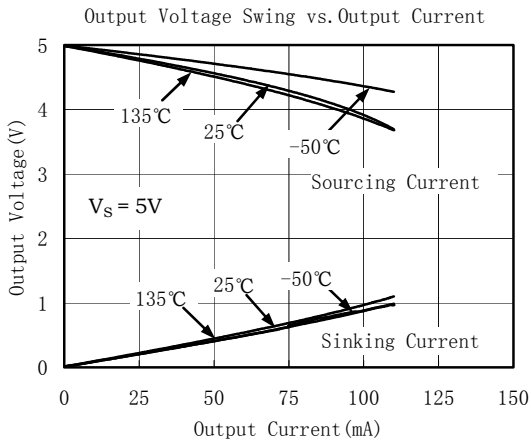
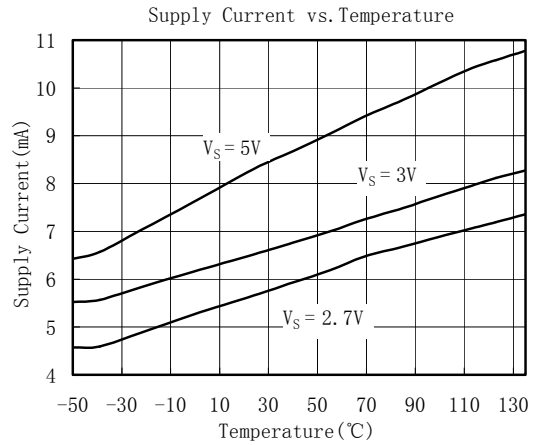
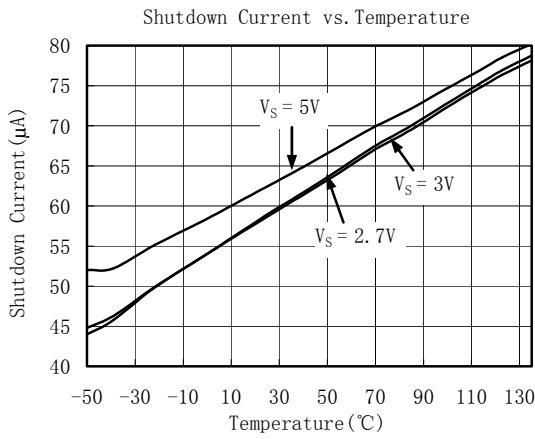
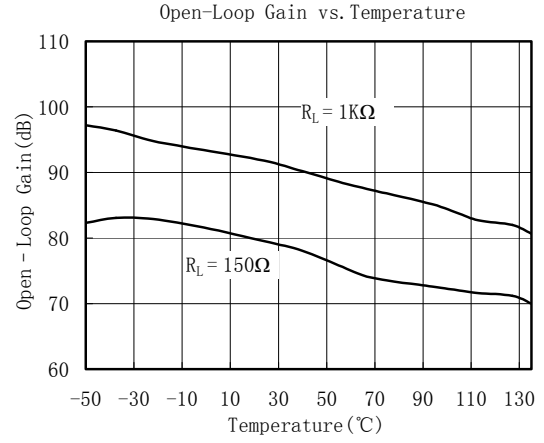
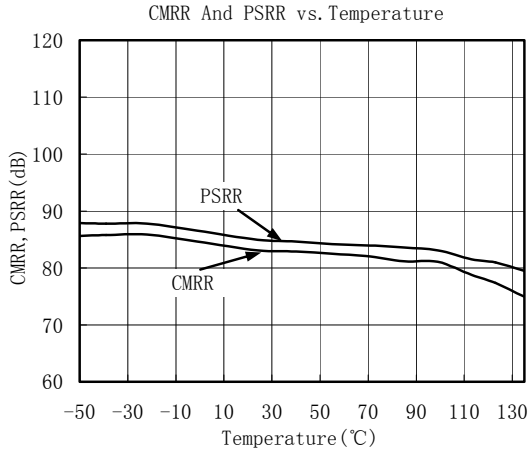
TYPICAL PERFORMANCE CHARACTERISTICS

At $T_A = +25^\circ\text{C}$, $V_S = +5\text{V}$, $G = +2$, $R_F = 402\Omega$, $R_G = 402\Omega$, and $R_L = 150\Omega$ connected to $V_S/2$, unless otherwise noted.



TYPICAL PERFORMANCE CHARACTERISTICS

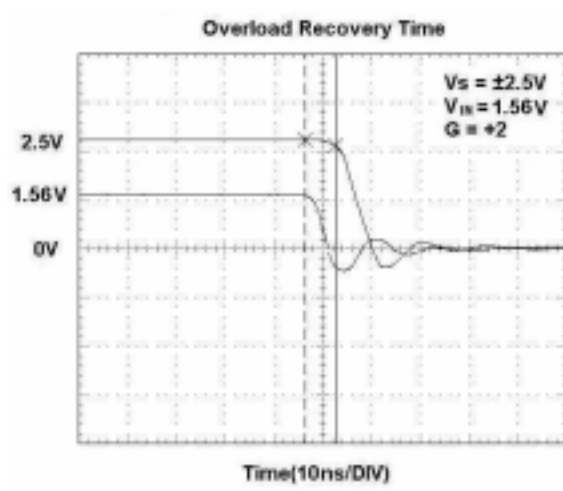
At $T_A = +25^\circ\text{C}$, $V_S = +5\text{V}$, $G = +2$, $R_F = 402\Omega$, $R_G = 402\Omega$, and $R_L = 150\Omega$ connected to $V_S/2$, unless otherwise noted.



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TYPICAL PERFORMANCE CHARACTERISTICS

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APPLICATION NOTES

Driving Capacitive Loads

The SGM806x family is optimized for bandwidth and speed, not for driving capacitive loads. Output capacitance will create a pole in the amplifier's feedback path, leading to excessive peaking and potential oscillation. If dealing with load capacitance is a requirement of the application, the two strategies to consider are (1) using a small resistor in series with the amplifier's output and the load capacitance and (2) reducing the bandwidth of the amplifier's feedback loop by increasing the overall noise gain.

Figure 1 shows a unity gain follower using the series resistor strategy. The resistor isolates the output from the capacitance and, more importantly, creates a zero in the feedback path that compensates for the pole created by the output capacitance.

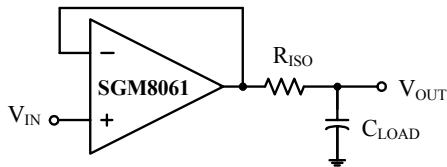


Figure 1. Series Resistor Isolating Capacitive Load

Power-Supply Bypassing and Layout

The SGM806x family operates from either a single +2.7V to +5.5V supply or dual $\pm 1.35V$ to $\pm 2.75V$ supplies. For single-supply operation, bypass the power supply V_{DD} with a $0.1\mu F$ ceramic capacitor which should be placed close to the V_{DD} pin. For dual-supply operation, both the V_{DD} and the V_{SS} supplies should be bypassed to ground with separate $0.1\mu F$ ceramic capacitors. $2.2\mu F$ tantalum capacitor can be added for better performance.

Good PC board layout techniques optimize performance by decreasing the amount of stray capacitance at the op amp's inputs and output. To decrease stray capacitance, minimize trace lengths and widths by placing external components as close to the device as possible. Use surface-mount components whenever possible.

For the high speed operational amplifier, soldering the part to the board directly is strongly recommended. Try to keep the high frequency big current loop area small to minimize the EMI (electromagnetic interfacing).

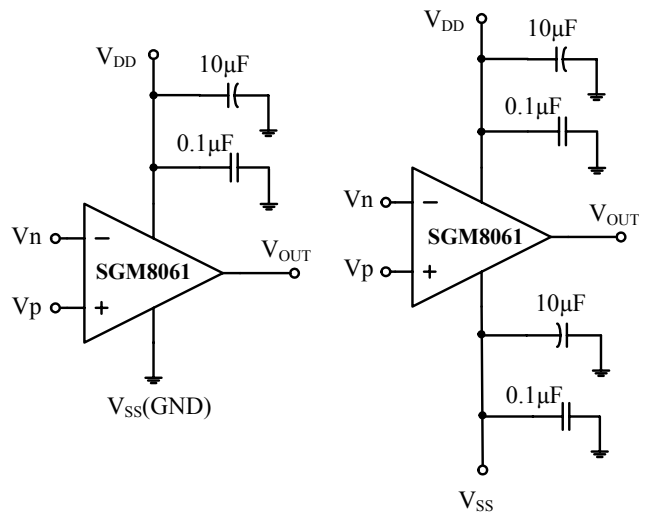


Figure 2. Amplifier with Bypass Capacitors

Grounding

A ground plane layer is important for high speed circuit design. The length of the current path speed currents in an inductive ground return will create an unwanted voltage noise. Broad ground plane areas will reduce the parasitic inductance.

Input-to-Output Coupling

To minimize capacitive coupling, the input and output signal traces should not be parallel. This helps reduce unwanted positive feedback.

Typical Application Circuits

Differential Amplifier

The circuit shown in Figure 3 performs the difference function. If the resistors ratios are equal ($R_4 / R_3 = R_2 / R_1$), then $V_{OUT} = (V_p - V_n) \times R_2 / R_1 + V_{ref}$.

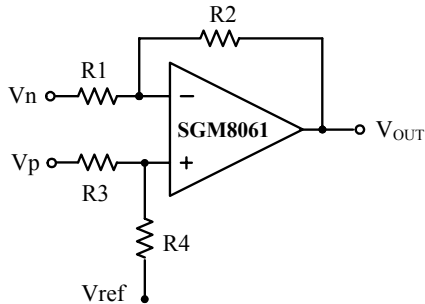


Figure 3. Differential Amplifier

Low Pass Active Filter

The low pass filter shown in Figure 4 has a DC gain of ($-R_2 / R_1$) and the -3dB corner frequency is $1/2\pi R_2 C$. Make sure the filter is within the bandwidth of the amplifier. The Large values of feedback resistors can couple with parasitic capacitance and cause undesired effects such as ringing or oscillation in high-speed amplifiers. Keep resistors value as low as possible and consistent with output loading consideration.

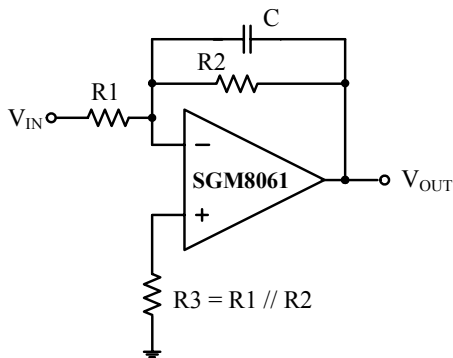
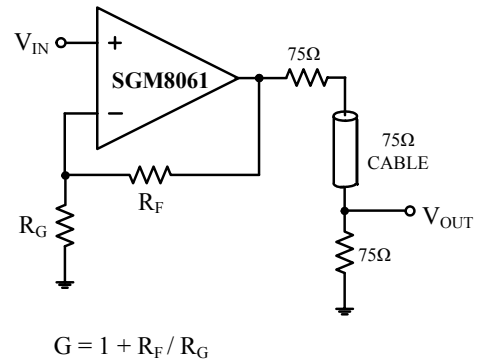


Figure 4. Low Pass Active Filter

Driving Video

The SGM806x can be used in video applications like in Figure 5.

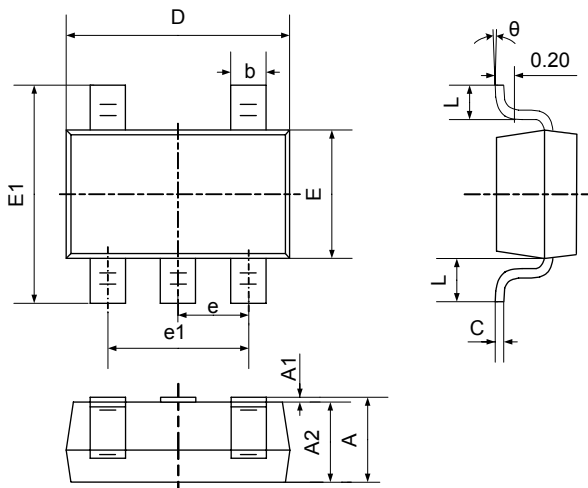


$$G = 1 + R_F / R_G$$

Figure 5. Typical Video Driving

PACKAGE OUTLINE DIMENSIONS

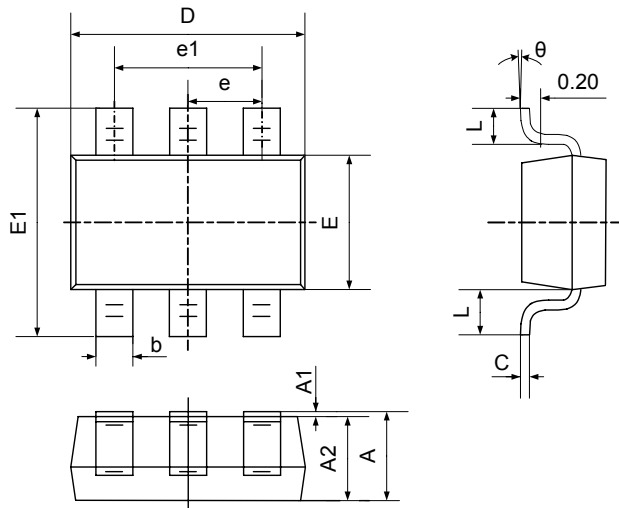
SOT23-5



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.400	0.012	0.016
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.700REF		0.028REF	
L1	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

PACKAGE OUTLINE DIMENSIONS

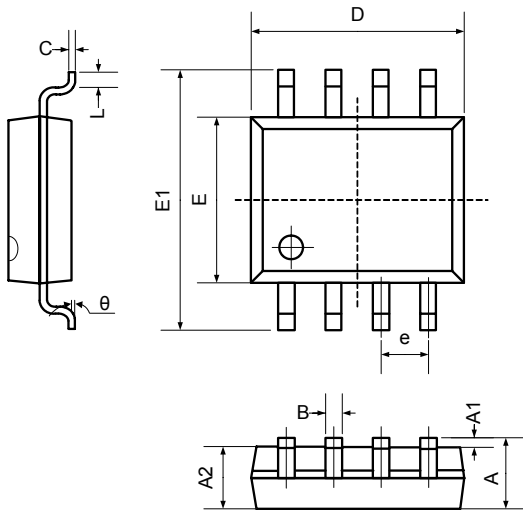
SOT23-6



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.400	0.012	0.016
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.700REF		0.028REF	
L1	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

PACKAGE OUTLINE DIMENSIONS

SO-8



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
B	0.330	0.510	0.013	0.020
C	0.190	0.250	0.007	0.010
D	4.780	5.000	0.188	0.197
E	3.800	4.000	0.150	0.157
E1	5.800	6.300	0.228	0.248
e	1.270TYP		0.050TYP	
L	0.400	1.270	0.016	0.050
theta	0°	8°	0°	8°

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REVISION HISTORY

Location	Page
11/06— Data Sheet changed from Preliminary to REV. A	
Changes to ABSOLUTE MAXIMUM RATINGS	3

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No.5, TaiHu Northern Street, YingBin Road Centralized Industrial Park
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